

JMPK1N60A/JMPH1N60A

Description

JMP N-channel MOSFET

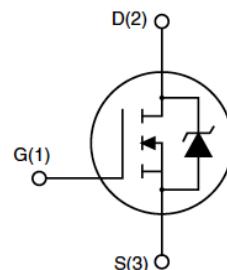
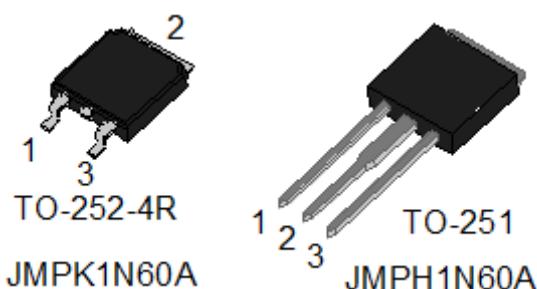
Features

- 600V, 1.3A
- $R_{DS(ON)} = 8.5\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 0.65A$
- Fast Switching
- Improved dv/dt Capability
- 100% Avalanche Tested

Application

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply(UPS)
- Power Factor Correction(PFC)

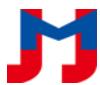
Package



Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise specified)

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		600	V
V_{GSS}	Gate-Source Voltage		± 30	V
I_D	Continuous Drain Current	$T_C = 25^\circ C$	1.3	A
		$T_C = 100^\circ C$	0.8	A
I_{DM}	Pulsed Drain Current ^{note1}		4	A
E_{AS}	Single Pulsed Avalanche Energy ^{note2}		20	mJ
dv/dt	Peak Diode Recovery Energy		5	V/ns
P_D	Power Dissipation	$T_C = 25^\circ C$	45	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.8	$^\circ C/W$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ C$

*Drain current limited by maximum junction temperature



JMPK1N60A/JMPH1N60A

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	600	-	-	V
$\Delta V_{(\text{BR})\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=250\mu\text{A}$	-	0.6	-	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600\text{V}, V_{GS} = 0\text{V}, T_J = 25^\circ\text{C}$	-	-	1	μA
		$V_{DS} = 480\text{V}, V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$	-	-	10	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 30\text{V}$	-	-	± 100	nA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D=250\mu\text{A}$	2.0	3.0	4.0	V
$R_{DS(\text{on})}$	Static Drain-Source on-Resistance note3	$V_{GS} = 10\text{V}, I_D = 0.65\text{A}$	-	8.5	10	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 40\text{V}, I_D = 0.65\text{A}$	-	0.9	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$	105	-	160	pF
C_{oss}	Output Capacitance		18.8	-	28.2	pF
C_{rss}	Reverse Transfer Capacitance		2.8	-	4.5	pF
Q_g	Total Gate Charge	$V_{DS} = 480\text{V}, I_D = 1\text{A}, V_{GS} = 10\text{V}$	-	6.1	8	nC
Q_{gs}	Gate-Source Charge		-	1.3	2	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	3.1	4	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DS} = 300\text{V}, I_D = 1\text{A}, R_G = 25\Omega$	-	10	13	ns
t_r	Turn-on Rise Time		-	10	18	ns
$t_{d(off)}$	Turn-off Delay Time		-	20	26	ns
t_f	Turn-off Fall Time		-	11.5	23	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current	-	-	1	A	
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	4	A	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_{SD} = 1\text{A}$	-	0.82	1	V
t_{rr}	Reverse Recovery Time	$V_{DS} = 100\text{V}, I_F = 1.3\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	114	137	ns
Q_{rr}	Reverse Recovery Charge		-	0.63	0.76	μC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. $L=60\text{mH}, I_{AS} = 1\text{A}, V_{DD} = 150\text{V}, R_G = 10 \Omega$, starting $T_J = 25^\circ\text{C}$

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 1\%$

Typical Performance Characteristics

Figure1: Output Characteristics

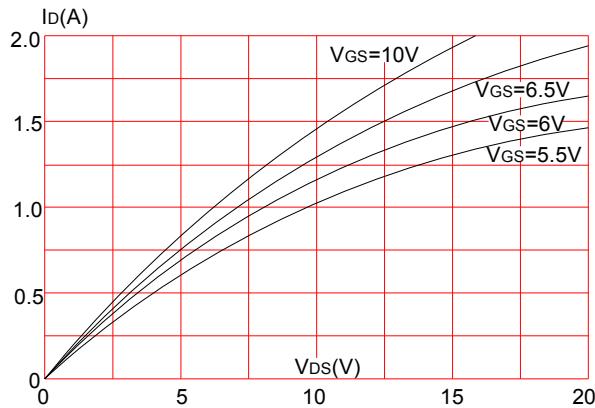


Figure 3: On-resistance vs Drain Current

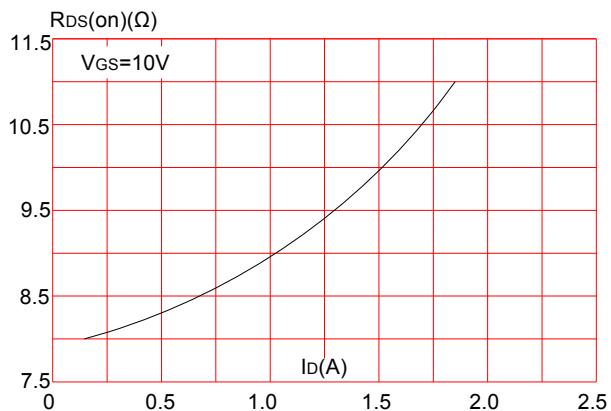


Figure 5: Gate Charge Characteristics

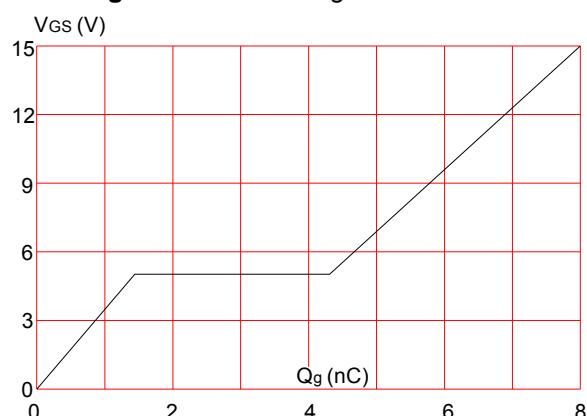


Figure 2: Typical Transfer Characteristics

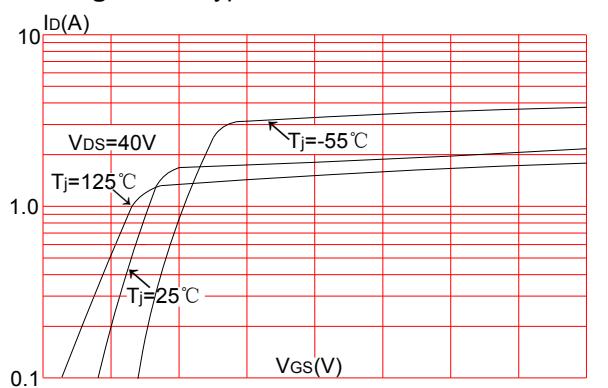


Figure 4: Body-Diode Characteristics

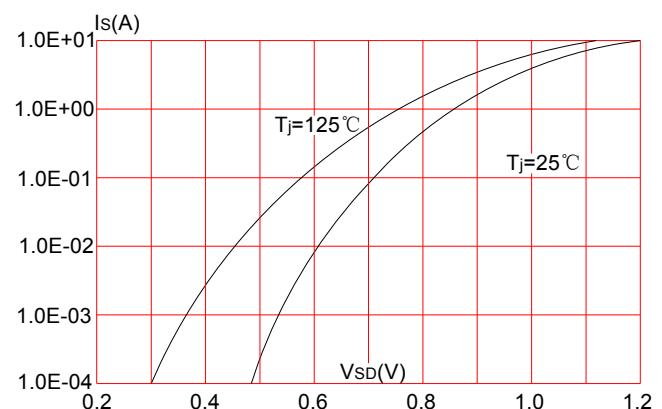


Figure 6: Capacitance Characteristics

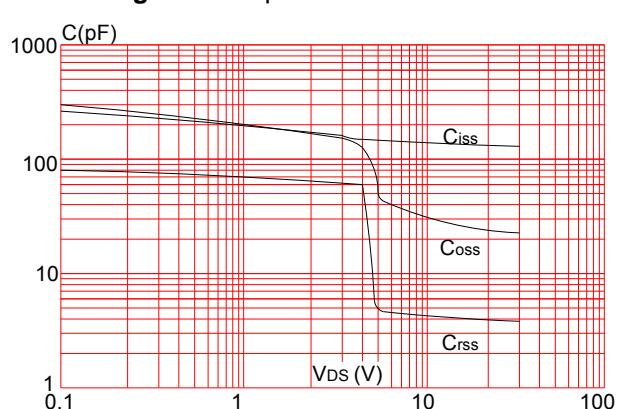


Figure 7: Breakdown Voltage vs Junction Temperature

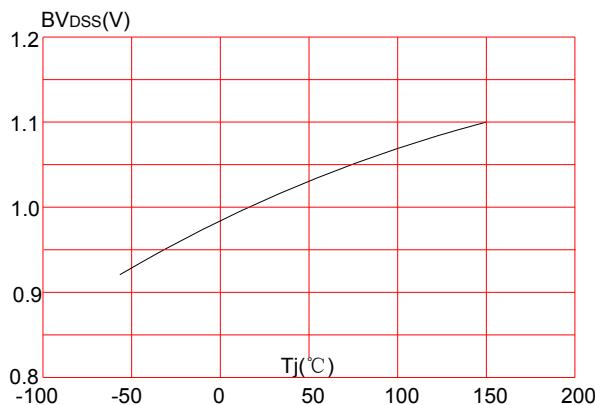


Figure 9: Maximum Safe Operating Area

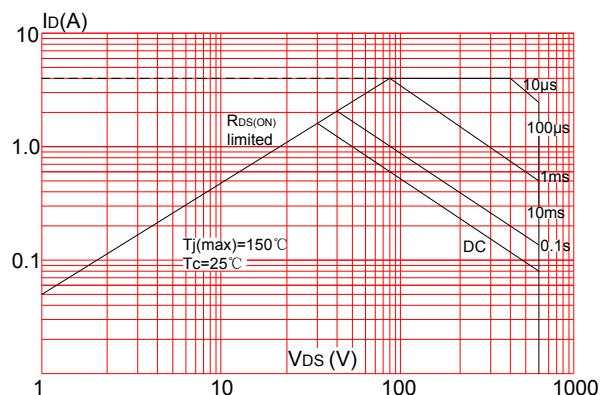


Figure 8: On-Resistance vs Junction Temperature

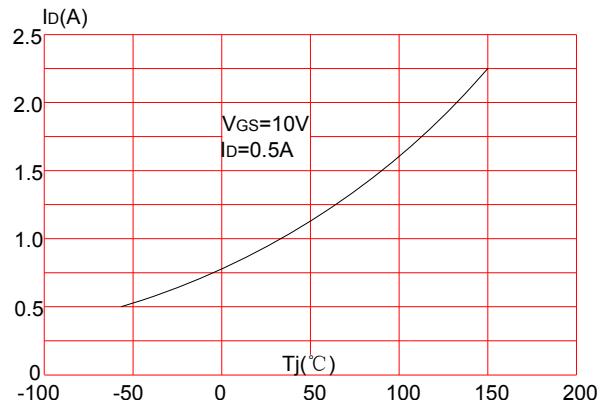


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

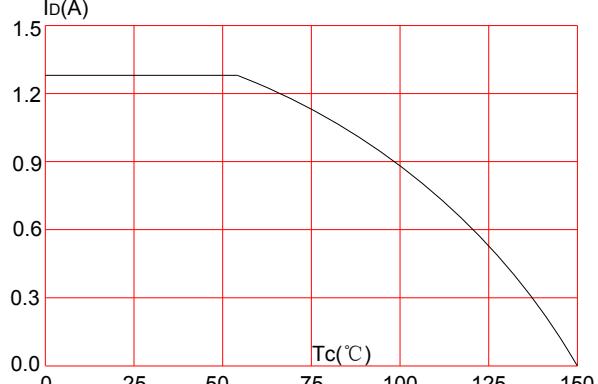
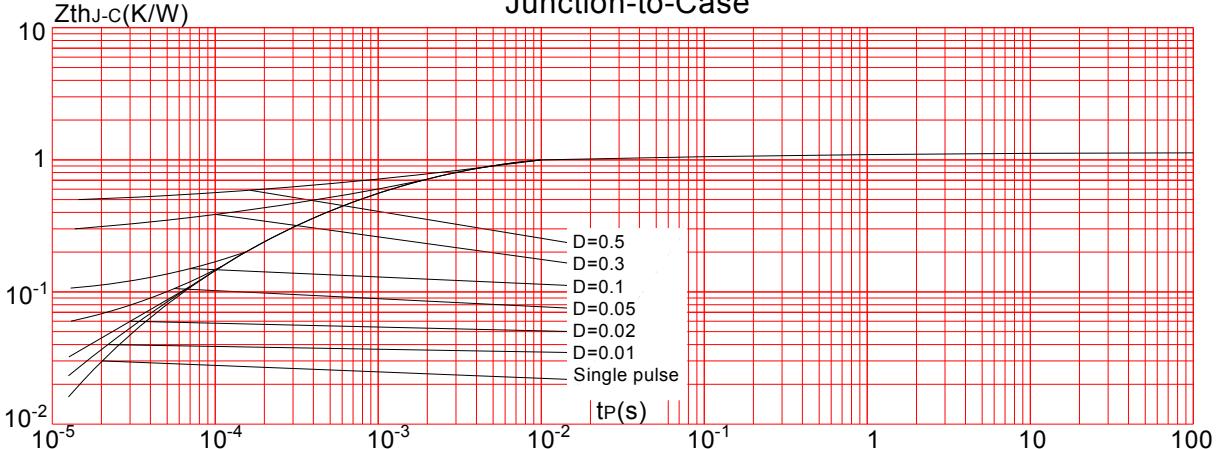


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



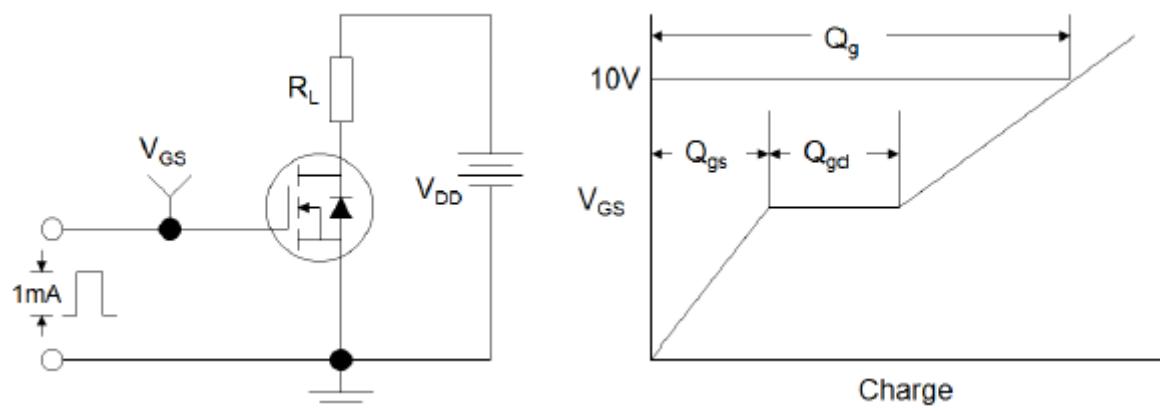


Figure 12: Gate Charge Test Circuit & Waveform

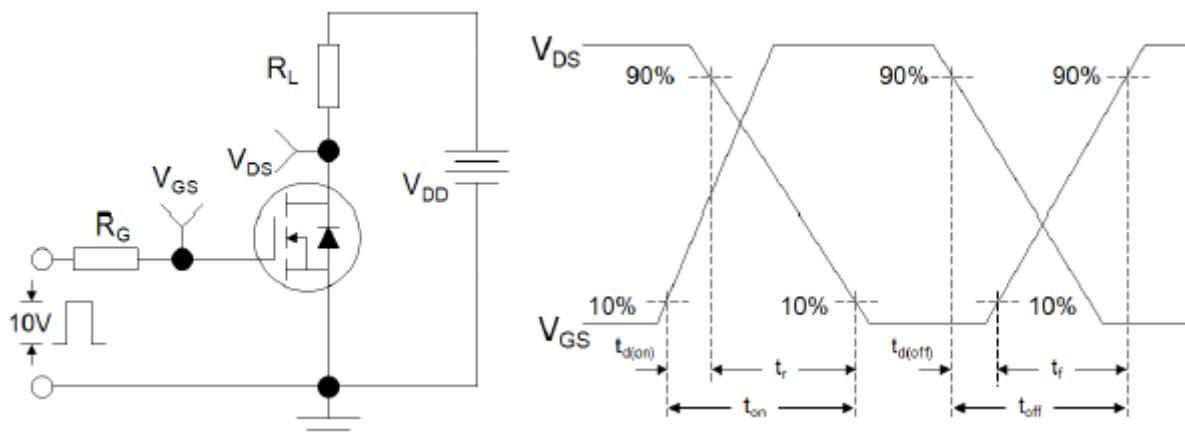


Figure 13: Resistive Switching Test Circuit & Waveforms

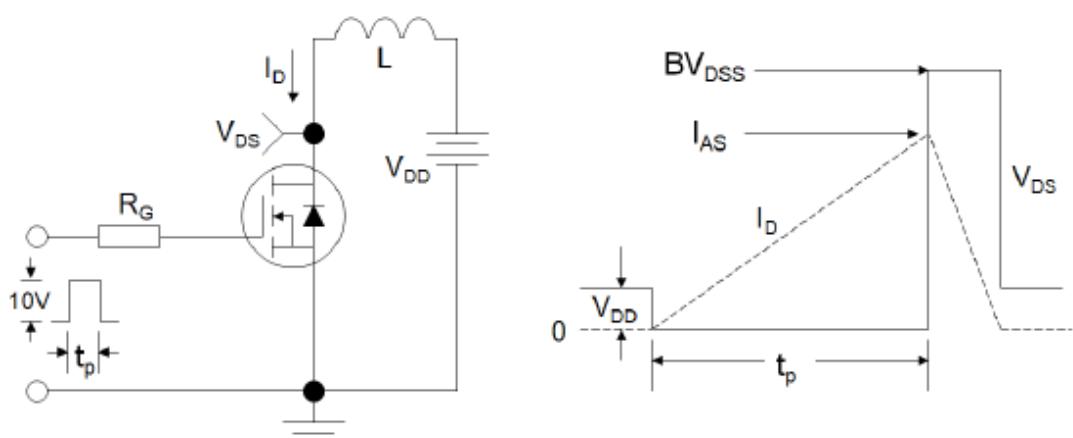


Figure 14: Unclamped Inductive Switching Test Circuit & Waveforms

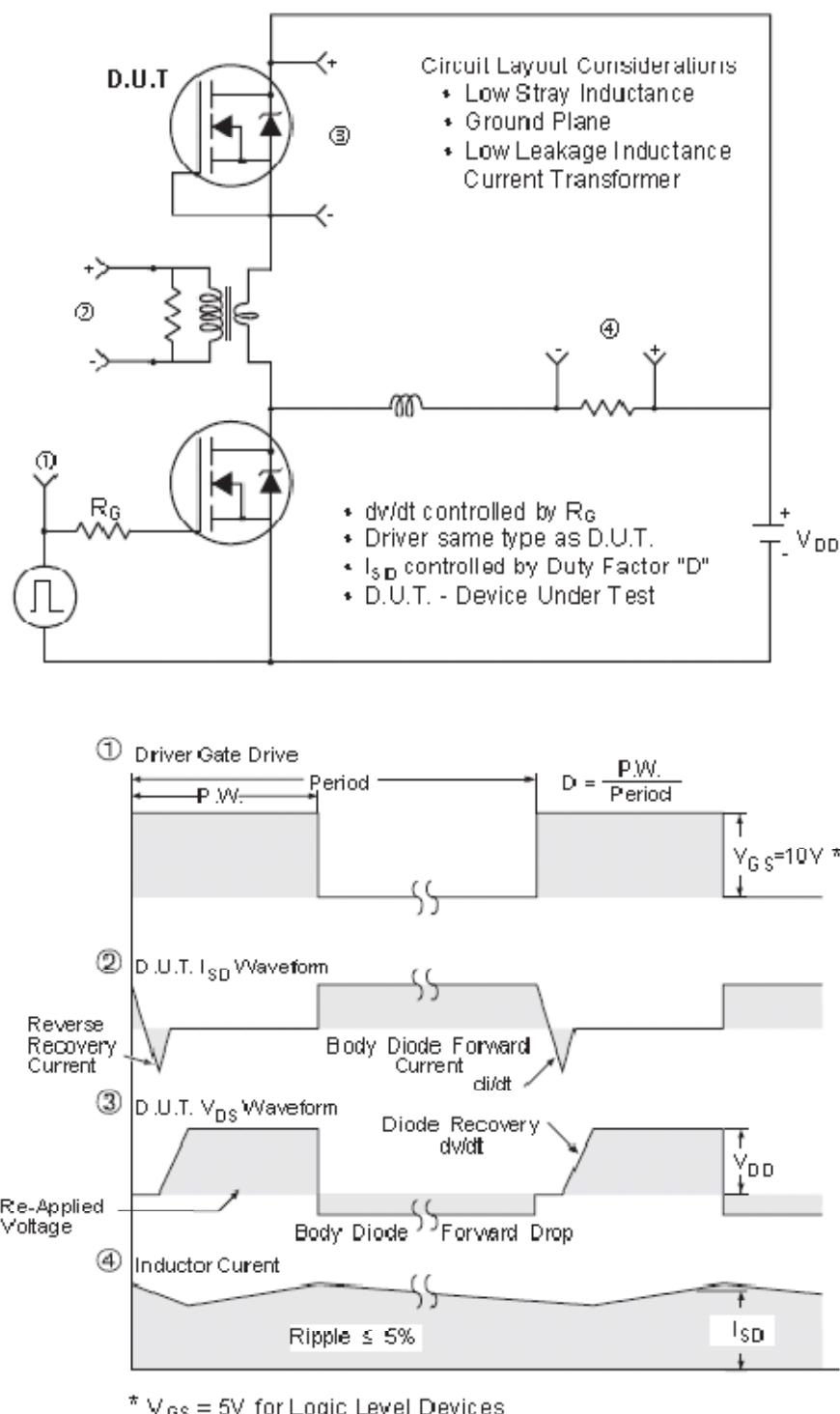
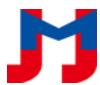
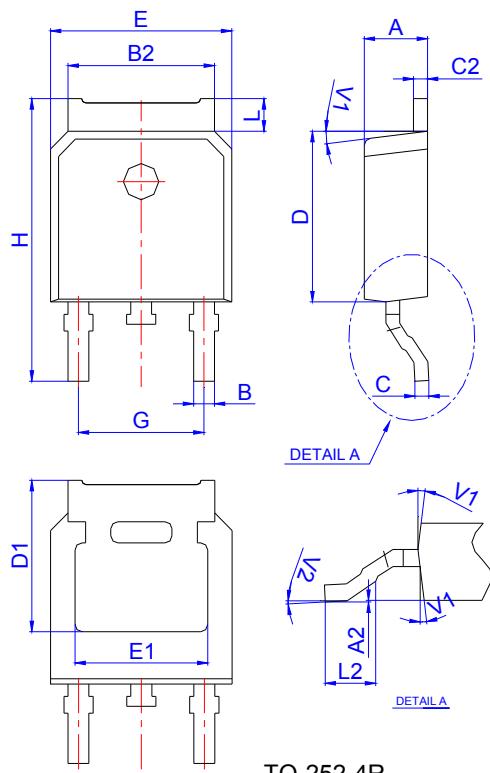


Figure 15: Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)



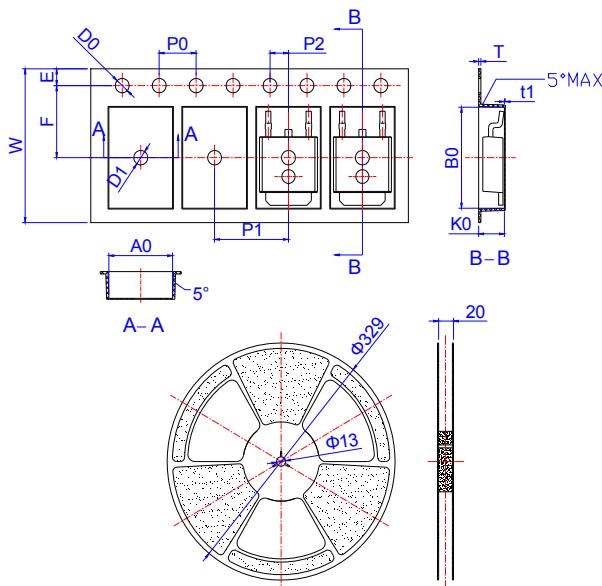
JMPK1N60A/JMPH1N60A

Package Mechanical Data



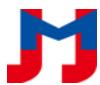
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO-252-4R

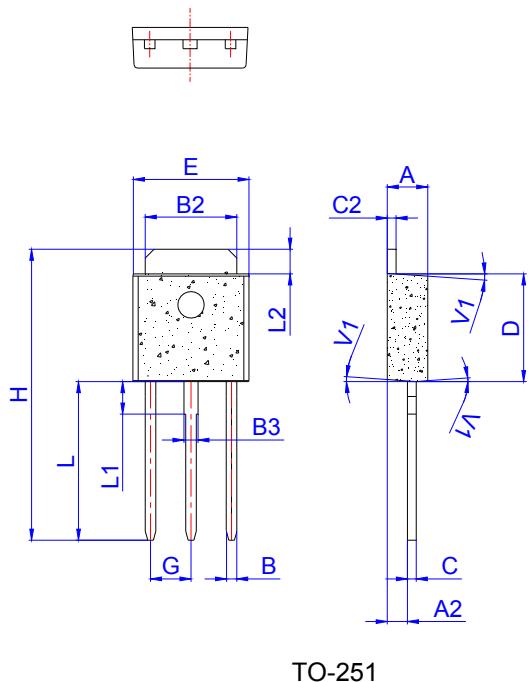


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

OUTLINE	REEL (PCS)	PER CARTON (PCS)	TAPE & REEL
TAPING	2,500	25,000	13inch



Package Mechanical Data



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.20		2.40	0.086		0.095
A2	0.90		1.20	0.035		0.047
B	0.55		0.65	0.022		0.026
B2	5.10		5.40	0.200		0.213
B3	0.76		0.85	0.030		0.033
C	0.45		0.62	0.018		0.024
C2	0.48		0.62	0.019		0.024
D	6.00		6.20	0.236		0.244
E	6.40		6.70	0.252		0.264
G		2.30			0.091	
H	16.0		17.0	0.630		0.669
L	8.90		9.40	0.350		0.370
L1	1.80		1.90	0.071		0.075
L2	1.37		1.50	0.054		0.059
V1		4°			4°	

Package Information -TO-251

OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON (PCS)
TUBE	80	4,000	32,000

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